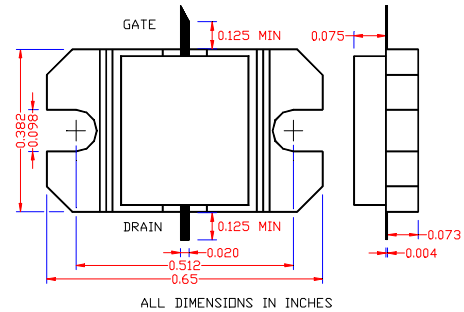


**Not recommended for new designs. Contact factory. Effective 03/2003**  
**10.7-11.7GHz, 2W Internally Matched Power FET**

- 10.7-11.7GHz BANDWIDTH AND INPUT/OUTPUT IMPEDANCE MATCHED TO 50 OHM
- EIA FEATURES HIGH PAE( 30% TYPICAL)
- EIB FEATURES HIGH IP3(46dBm TYPICAL)
- +33.5/+33.0dBm TYPICAL  $P_{1dB}$  OUTPUT POWER FOR EIA/EIB
- 9.5/8.5dB TYPICAL  $G_{1dB}$  POWER GAIN FOR EIA/EIB
- NON-HERMETIC METAL FLANGE PACKAGE


**ELECTRICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )**

SYMBOLS	PARAMETERS/TEST CONDITIONS	EIA1011-2P			EIB1011-2P			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
$P_{1dB}$	Output Power at 1dB Compression $f=10.7-11.7\text{GHz}$ $V_{ds}=8\text{V}$ , $I_{dsq}=0.5 I_{dss}$ (EIA), $0.6 I_{dss}$ (EIB)	32.5	33.5		32	33.0		dBm
$G_{1dB}$	Gain at 1dB Compression $f=10.7-11.7\text{GHz}$ $V_{ds}=8\text{V}$ , $I_{dsq}=0.5 I_{dss}$ (EIA), $0.6 I_{dss}$ (EIB)	8.5	9.5		7.5	8.5		dB
PAE	Power Added Efficiency at 1dB compression $f=10.7-11.7\text{GHz}$ $V_{ds}=8\text{V}$ , $I_{dsq}=0.5 I_{dss}$ (EIA), $0.6 I_{dss}$ (EIB)		30			25		%
$I_{d1dB}$	Drain Current at 1dB Compression		880			850		mA
IP3	Output 3 <sup>rd</sup> Order Intercept Point $f=10.7-11.7\text{GHz}$ $V_{ds}=8\text{V}$ , $I_{dsq}=0.5 I_{dss}$ (EIA), $0.6 I_{dss}$ (EIB)		40			46*		dBm
$I_{dss}$	Saturated Drain Current $V_{ds}=3\text{V}$ , $V_{gs}=0\text{V}$	1100	1440	1700	1100	1360	1700	mA
$G_m$	Transconductance $V_{ds}=3\text{V}$ , $V_{gs}=0\text{V}$		1500			700		mS
$V_p$	Pinch-off Voltage $V_{ds}=3\text{V}$ , $I_{ds}=12\text{mA}$		-1.0	-2.5		-2.0	-3.5	V
$BV_{gd}$	Drain Breakdown Voltage $I_{gd}=4.8\text{mA}$	-13	-15			-15		V
$R_{th}$	Thermal Resistance (Au-Sn Eutectic Attach)		8			8		$^\circ\text{C}/\text{W}$

\*Typical -45dBc IM3 at  $P_{out}=23\text{dBm}/\text{Tone}$

**MAXIMUM RATINGS AT  $25^\circ\text{C}$** 

SYMBOLS	PARAMETERS	ABSOLUTE <sup>1</sup>	CONTINUOUS <sup>2</sup>
$V_{ds}$	Drain-Source Voltage	12V	8V
$V_{gs}$	Gate-Source Voltage	-8V	-3V
$I_{ds}$	Drain Current	$I_{dss}$	$I_{dss}$
$I_{gsf}$	Forward Gate Current	180mA	30mA
$P_{in}$	Input Power	32dBm	@ 3dB Compression
$T_{ch}$	Channel Temperature	175 $^\circ\text{C}$	150 $^\circ\text{C}$
$T_{stg}$	Storage Temperature	-65/175 $^\circ\text{C}$	-65/150 $^\circ\text{C}$
$P_t$	Total Power Dissipation	17W	14.2W

Note: 1. Exceeding any of the above ratings may result in permanent damage.

2. Exceeding any of the above ratings may reduce MTTF below design goals.